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Antibacterial properties of TiO₂-Cu composite thin films grown by a one step DLICVD process[☆]

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A B S T R A C T

The correlations between microstructural features, chemical compositions and antibacterial properties of coatings containing metallic Cu particles embedded in a titanium dioxide matrix have been determined. A Direct Liquid Injection Chemical Vapor Deposition (DLICVD) process was used for the one step growth of TiO₂-Cu composite coatings on various substrates. Titanium tetra-*iso*-propoxide (TTIP) and copper bis(2,2,6,6-tetramethyl-3,5-heptationate) (Cu(tmhd)₂) were used as titanium and copper molecular sources, respectively. This growth process allows a good control of the quantity of metalorganic precursors injected into the CVD reactor and thus of the coating composition. The deposition occurs at 683 K under low pressure (800 Pa). The influence of the main features of the coatings on their antibacterial properties was investigated in order to produce bactericidal surfaces that are durable, non-toxic and containing a minimum amount of active agent. The antibacterial activity on *Staphylococcus aureus* without any photon activation was measured according to the JIS Z 2801:2000 standard method. An antibacterial activity was detected for a low metal content of ca. 1 at.% Cu, and was found to increase with the Cu content. It was maximal for 3.5 at.% Cu, *i.e.* TiO₂-Cu composite coatings exhibit bactericidal behavior against *S. aureus* for this optimal composition (relative activity = 100%). In order to better characterize the microbiological behavior of the coatings more discriminating methods derived from the literature were tested to assess the performances of these CVD coatings in terms of efficiency, release of antibacterial agent and accelerated aging.

1. Introduction

Antibacterial properties of silver and copper have been well known for many centuries. As a result these metals are frequently used as active agents in coatings to produce antibacterial surfaces. Silver has been used to treat wounds, ophthalmia neonatorum, and more recently, in combination with sulfadiazine, burns (for a review see [1]). Silver ions (Ag⁺) interact with disulfide or sulfhydryl groups of enzymes, leading to inhibition of metabolic processes [2,3]. Silver also binds bacterial DNA (deoxyribonucleic acid) inhibiting replication and transcription [4,5]. Copper leads to the collapse of some lipopolysaccharide (LPS) patches and alters the permeability and functionality of the outer cell membrane [6]. Due to their small size (<100 nm), nanoparticles (NPs) present a larger surface area/volume ratio and greater chemical activity than larger particles. Silver nanoparticles exhibit an antibacterial activity at low

concentration [7,8]. It has been demonstrated that their activity is size [7,9] and shape dependent [10].

Free NPs penetrate inside the bacteria after their attachment to the plasma membrane and they interact with sulfur-containing proteins and the phosphorus containing-DNA. Then, the respiratory chain and cell division are blocked [1]. The nanometric size of silver NPs, *i.e.* smaller than 10 nm, also produces electronic effects [11,12]. It is still difficult to distinguish the bactericidal activity of NPs from that of metallic ions released by nanoparticles [13–15]. The action mechanism of copper nanoparticles is less understood than silver ones [16,17], due to less studies than for silver element.

Several processes are developing to immobilize NPs on surfaces and the main way is to incorporate them in a thin matrix to form composite coatings. Thereby nanocomposite films have been synthesized by sol-gel deposition [18–20]. In all cases, the active species, *i.e.* Ag⁺ cations, are released from NPs immobilized on the support. Furno et al. [21] dissolved organometallic precursors in supercritical carbon dioxide in order to obtain a homogenous distribution of NPs in a silicone matrix. Egger et al. [22] used an industrial flame spray pyrolysis process to synthesize a SiO₂-Ag nanocomposite material. Kelly et al. [23] deposited

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TiN–Ag by pulsed magnetron sputtering. Brook et al. [24] and Sheel D.W. et al. [25] synthesized silver and TiO₂–Ag duplex coatings with antibacterial properties by means of Chemical Vapor Deposition (CVD) while Page et al. [26] deposited TiO₂–Ag antimicrobial composite films on glass. As already mentioned, there is less report on Cu than on Ag as an active antibacterial agent.

The use of a photocatalytic oxide matrix is another route to produce antibacterial coatings but UV activation is generally required. For instance Cu/WO₃ was added as visible-light-sensitive photocatalyst to PTFE particulate composite material to overcome this limitation and a synergistic effect was also found on antibacterial performance. In fact the antibacterial activity of this Cu/WO₃-added PTFE particulate composite material decreases significantly with the visible light intensity [27]. The remarkable photo-excited properties of TiO₂ films have been described in many reviews where the photocatalytic sterilization process is also discussed [28]. The antimicrobial efficiency of TiO₂ coatings by photocatalytic reactions was investigated under UV-A irradiation but its application is limited under UV light [29]. It was demonstrated that TiO₂/cordierite foam irradiated with UV-A light possessed both a long-term bactericidal action and a high photocatalytic degradation capability making this material a good candidate for air-cleaning filters but, again, UV light is required [30].

In previous studies, we developed a one step Direct Liquid Injection Chemical Vapor Deposition (DLICVD) process using metalorganic sources for the growth of nanostructured TiO₂–Ag [8] and TiO₂–Cu [31] coatings on various substrates. In both cases, the titanium precursor for the growth of the titanium oxide matrix was titanium tetra-*iso*-propoxide (TTIP). For the copper containing composite coatings copper bis(2,2,6,6-tetramethyl-3,5-heptationate) (Cu(tmhd)₂) was used as molecular precursor. The metallic Cu particles were incorporated into the TiO₂ matrix and uniformly distributed over the entire thickness of the film. For low Cu content, TiO₂ presented the anatase structure while by increasing the Cu content the nucleation and growth of rutile occurred. A preliminary investigation of the behavior of these nanocomposite TiO₂–Cu coatings had shown an antibacterial activity [31].

The aim of this paper is to report a thorough investigation on the influence of the main features of the films including thickness and Cu content as well as reproducibility and aging effect on the antibacterial properties of these TiO₂–Cu nanocomposite coatings without any UV activation. It was found that the JIS Z 2801:2000 standard method did not allow two composite films to be distinguished in spite of different features. Then, more discriminatory microbiological methods derived from the literature were implemented to assess the performances of these coatings.

2. Experimental

2.1. Growth of nanocomposite films

For DLICVD of TiO₂–Cu films, TTIP was diluted in xylene with a concentration of 1 mol·L⁻¹. The injection parameters were maintained constant: injection frequency 2 Hz and opening time 2 ms. Cu(tmhd)₂ was dissolved in pure xylene at a concentration between 0.01 and 0.05 mol·L⁻¹ depending on the level of Cu desired in the films. The copper incorporated into the coatings was also controlled by the injection frequency of the Cu(tmhd)₂ injector regulated between 0.5 and 6 Hz while the opening time was fixed at 2 ms. The substrates were silicon wafers, glass and stainless steel 316L. The total pressure was maintained at 800 Pa and the reactor wall and substrate holder were heated at 523 and 683 K, respectively. The film thickness was controlled by varying the deposition time. More details are reported in [31].

2.2. Film characterization

The crystalline structure of the films and the average crystallite size were determined by X-ray diffraction (Seifert 3000TT diffractometer;

Bragg–Brentano configuration; Cu K α radiation). The morphology and thickness of the films were observed using a scanning electron microscope (Leo 1530 FEG-SEM) equipped with an X-ray energy dispersive spectroscopy analyzer (EDS; Tracor analyzer). The size and the distribution of metal NPs were determined by transmission electron microscopy (TEM; JEOL JEM 2010 microscope). The relative composition of the films were analyzed by electron probe microanalysis (EPMA; Cameca SX50), secondary ion mass spectroscopy (SIMS; Cameca IMS 4F6 spectrometer) and X-ray photoelectron spectroscopy (XPS) using a VG ESCALAB MKII spectrophotometer, which operated with a non-monochromatized Mg K α source (1253.6 eV). Atomic composition of the layers was determined by XPS after Ar⁺ sputtering for 10 min to clean the atmospheric contamination of the surface.

2.3. Microbiological tests

Antibacterial properties of active films deposited on glass were measured according to the JIS Z 2801:2000 standard [32] using *Staphylococcus aureus* strain (CIP 4.83). The method was slightly modified to accommodate the size of the samples (25 × 25 mm² instead of 50 × 50 mm²). The test duration was also changed for a specific series of samples in order to investigate kinetic effects. Briefly, a bacterial suspension with 3 × 10⁵ CFU·mL⁻¹ was prepared in 1/500 nutrient broth. Then, 200 μ L (\approx 6 × 10⁴ CFU) was spread on 25 × 25 mm² samples and covered with a sterile plastic film. The samples were incubated in a humid chamber (RH 90%) from 3 h to 24 h at 37 °C. After incubation the samples were washed in a universal neutralizer solution (Fisher Scientific Bioblock, ref W1801L) to enable bacterial enumeration by means of a plate count. A control (reference) consisting of an uncoated sample was also tested for each analyzed sample. The antibacterial activity was calculated by the following formula:

$$\text{Antibacterial activity} = \text{Log}(A/B) \quad (1)$$

where A and B are the numbers of CFUs (Colony Forming Units) on the surface of the reference and coated samples, respectively. For greater convenience, we calculated also a relative antibacterial activity according to:

$$\text{Relative activity} = [\text{Log}(A/B) / \text{Log}(A)] * 100. \quad (2)$$

This relative activity means that (i) when it is equal to 100% (no CFU detected after the test) the surface is bactericidal, *i.e.* the number of CFUs is reduced from about 6 × 10⁶ CFU·mL⁻¹ (the amount usually counted on the control) to zero, (ii) in the range 0–100% the surface exhibits an antibacterial behavior and (iii) zero means that the surface is inactive.

The retained bacterial enumeration for each sample was the average value of three identical samples prepared in the same CVD run. The measure could not be replicated on the same sample because to avoid contamination the samples were autoclaved at 120 °C after the microbiological test and therefore their characteristics are likely to have evolved. Uncertainty in bacteriology is usually one logarithm that is about 15% for this test (1 log compared to 6–7 logarithms for the number of CFUs on the control). If one of the three measures deviated from this range the average was made on the other two samples. Consequently, each experimental data is reported hereafter with a 15% error bar representative of the standard deviation.

Moreover, we adapted the method of Haldar et al. [33] to test for bactericidal action of TiO₂–Cu composite coatings under different conditions. Briefly, TiO₂–Cu films 60 nm thick were deposited on 75 × 25 mm² glass samples. They were placed vertically at 15 cm in front of a spray nozzle and sprayed until the slide was uniformly wet (aerosol flow 10 mL·min⁻¹) with a *S. aureus* suspension (approximately 5 × 10³ cells·mL⁻¹). Then, the slides were dried in air for 2 min in a laminar flow cabinet, placed in Petri dishes and covered with pre-cut

agar growth medium (thickness 2 mm) [33]. After 24 h of incubation at 37 °C, CFUs were counted, each CFU corresponding to at least one surviving bacterium. Each test included one inactive control (a glass slide without TiO₂-Cu composite coating). The number of colonies on a sample must be lower than approximately 120–150 to facilitate bacterial enumeration. If there is not bacteria on the sample this means it is active, if the number of bacteria is the same as the control it is inactive.

2.4. Diffusion test

In order to determine if active antibacterial agent could release or diffuse from the films to the environment, the active face of coated sample with a composition of 3.5 at.% Cu was placed in contact with the surface of an agar plate previously inoculated with an *Escherichia coli* suspension containing 10⁶ CFU·mL⁻¹. After 24 h of incubation the possible occurrence of an inhibition zone around the sample is sought as a signature of diffusion of the antibacterial agent [34].

To complete this test of release or diffusion in an aqueous medium, three TiO₂-Cu films (100 nm thick) deposited on glass substrate were immersed separately in 20 mL double distilled water respectively at 20 °C and 40 °C for 24 h and at 40 °C for 7 days. The solutions were gently stirred during immersion. Then, traces of copper in the water were analyzed by inductively coupled plasma atomic emission spectroscopy (ICP-AES). Three analyses have been performed for each sample and the average value was retained. A control solution of 5 ppm Cu was analyzed to check the sensitivity and the calibration of ICP-AES spectrometer and a test with an uncoated glass substrate was carried out as blank test. The detection limit for Cu is typically 5 ppb.

2.5. Aging tests

An evaluation of the aging of such DLICVD TiO₂-Cu composite coatings was conducted during 5 months. Two sets of glass samples (75 × 25 mm²) coated on one side with a very thin film (60 nm thick) which contained 9 at.% Cu were placed in a climatic chamber in dark at 20 °C with a relative humidity (RH) of 40% (condition # 1) and at 60 °C with an RH of 100% (condition # 2). The antibacterial activity was evaluated on 3 series of samples for each aging condition, respectively immediately after the deposition and after 2 and 5 months, according to the JIS Z 2801 standard with *S. aureus*.

3. Results

3.1. Influence of Cu content on the antibacterial activity

Although the accuracy is not high the XPS technique was used to determine the composition of copper inside the TiO₂ matrix because of the very small thickness of the films. The Cu content increases with the mole fraction of the copper precursor Cu(tmhd)₂ as shown in Fig. 1.

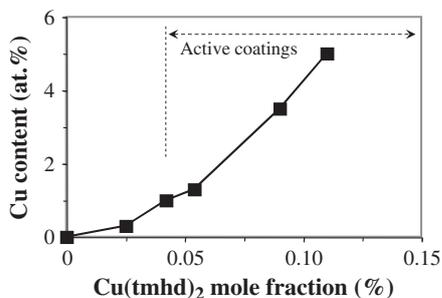


Fig. 1. Effect of Cu(tmhd)₂ mole fraction on the Cu content in TiO₂-Cu composite coatings as determined by XPS analyses. Antibacterial activity was observed for mole fractions higher than 0.025; typically for Cu content ≥ 1 at.% as indicated by the arrow. Partially reproduced after permission from Elsevier [31].

For instance, for a mole fraction of 0.025%, the Cu content in the film is around 0.3 at.% then it increases to ca. 5 at.% Cu for a mole fraction of 0.12%. The Cu incorporation in the coatings can be increased above this value but the goal of this work was to obtain bactericidal surfaces for the lowest levels of the active agent. Fig. 1 was partially reproduced from the data of Fig. 7 in [31] because we noticed an error in this figure where the two Y axes were reversed, i.e. the XPS data corresponded to the black triangles instead of the black squares (which did not change the comments of this earlier paper).

The antibacterial activity for different series of samples measured by the JIS method with a contact time of 24 h was detected for a Cu(tmhd)₂ mole fraction higher than 0.04% which corresponded to a film composition of ca. 1 at.% Cu (Fig. 2). It was maximal for a Cu(tmhd)₂ mole fraction near 0.1% which corresponded to ca. 3.5 at.% Cu. Three series of samples were prepared using the same DLICVD conditions for 3 different deposition times. Consequently, the film thicknesses were equal to 100, 150 and 200 nm. XPS technique was used to analyze the Cu content in these thin films. The relative antibacterial activity increased from 0 at ca. 1 at.% Cu to its maximum (100%) at ca. 3.5 at.% Cu. No biological activity was observed when the Cu content was below the detection limit of XPS (<ca. 1 at.%). The results in Fig. 2 exhibit a good reproducibility whatever the thickness of the film in the range 100–200 nm. Other data confirmed the good reproducibility and an activity threshold close to 1 at.% Cu.

3.2. Influence of the thickness and microstructure of films

Fig. 2 revealed already an effect of the film thickness on the antibacterial activity since the activity seemed to be better for the thickest coatings. We studied the influence of the film thickness for the same mole fraction of Cu(tmhd)₂ on another series of samples. The relative activity increased from 45% for a thickness of 35 nm (antibacterial activity) to 100% (bactericidal activity) for a thickness of about 107 nm (Fig. 3). Above this critical value the thickness has no effect on the antibacterial behavior as mentioned above since it is already at its maximum (100%).

Surface SEM micrographs showed that large Cu particles (average size 200–300 nm) partially protruded from the film surface because they are larger than the film thickness. As a result, they were preferentially situated near the external surface (Fig. 4). In a previous paper we had also shown by transmission electron microscopy that smaller Cu particles (nanoparticles) were embedded into the oxide matrix to form these composite coatings [31].

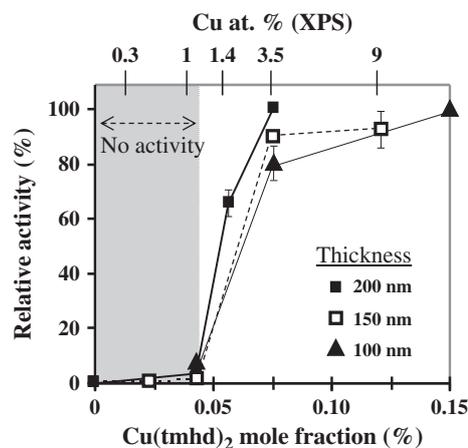


Fig. 2. Influence of Cu(tmhd)₂ mole fraction on the antibacterial activity determined by the JIS method for three series of coatings with different thicknesses reported in the inset. The estimated Cu content of the films determined by XPS is also reported on the upper x-axis, as deduced from Fig. 1. An error bar is estimated at 15% for all samples (except for samples 100% active since there was no CFU detected) but it is given only for a representative data of each series for clarity.

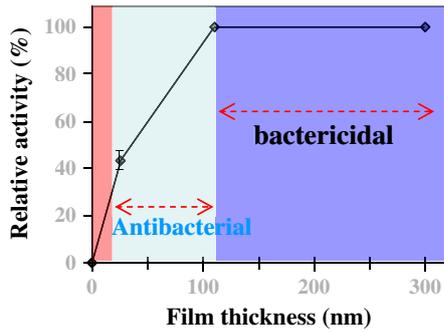


Fig. 3. Influence of the film thickness on antibacterial activity: the coatings were deposited using the same $\text{Cu}(\text{tmhd})_2$ mole fraction. An antibacterial intermediate zone between inactive and bactericidal surfaces is indicated.

3.3. Antibacterial activity by different methods

3.3.1. Modified JIS standard as kinetic method

The antibacterial activity of TiO_2 -Cu composite films was tested by other microbiological methods to assess their effectiveness through kinetic information. The JIS method was adapted and the antibacterial activity was measured for different contact times. Two films of 100 nm thick containing 1.3 at.% Cu and 3.5 at.% Cu respectively were tested by the means of JIS Z 2801 standard [32]. Each of them exhibited a bactericidal activity after 24 h of incubation. However by changing the contact time they revealed different behaviors. Fig. 5 shows that the bactericidal effect (relative activity = 100%) was observed after 24 h of incubation when the Cu concentration was low (1.3 at.% corresponding to 0.054% mole fraction of $\text{Cu}(\text{tmhd})_2$) and after only 3 h for samples containing a larger amount of Cu (3.5 at.% Cu corresponding to 0.074% mole fraction of $\text{Cu}(\text{tmhd})_2$).

3.3.2. Competition method (Haldar method)

When the bacteria were deposited directly onto the surface of TiO_2 -Cu composite films by means of an aerosol [33], their inhibition was measured by counting the CFUs developed on the agar after 24 h of incubation. The results from three experiments showed that no antibacterial effect was noted for a Cu content of 3.5 at.% (no inhibition observed), whereas the same coating was bactericidal according to the JIS method. For the sample containing 9 at.% Cu the relative activity

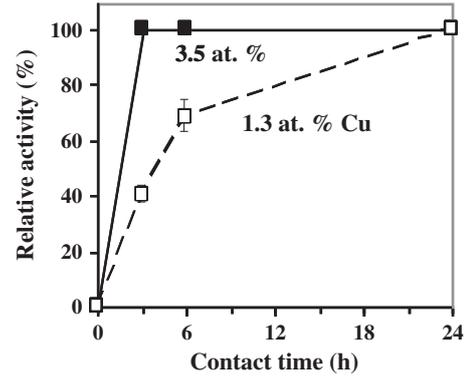


Fig. 5. Kinetic method (modified JIS Z 2801 standard) showing that for high Cu content (3.5 at.%) the bactericidal effect is achieved after 3 h of incubation whereas for low Cu contents (1.3 at.%) the bactericidal action requires 24 h of incubation revealing a lower activity.

significantly increases to reach 32%. Table 1 summarizes these results. The number of CFUs on the control slide was intentionally reduced to around 150 to allow their development under optimal conditions.

3.3.3. Diffusion test

The absence of diffusion zone around an active TiO_2 -Cu sample placed on the agar plate previously inoculated with *E. coli* clearly revealed that no inhibition zone was observed which would result from the diffusion of antibacterial agent from the sample (Fig. 6).

Furthermore Table 2 shows ICP-AES analyses of the water after immersion of TiO_2 -Cu films (100 nm thick; deposited on glass substrate) for 24 h at 20 °C and 40 °C, and 7 days at 40 °C. The data did not give evidence for Cu release in pure water.

3.3.4. Aging tests

Before starting the aging tests, the relative activity of the selected as-deposited TiO_2 -Cu samples was 100% as measured by the JIS standard method (Fig. 2) and it was the highest by the Haldar method (Table 1). The variation of the antibacterial properties determined by the JIS standard method is presented in Fig. 7 for different aging conditions. A decrease of the efficiency was observed with aging. This decrease was higher for the more severe condition (# 2), i.e. 60 °C/RH

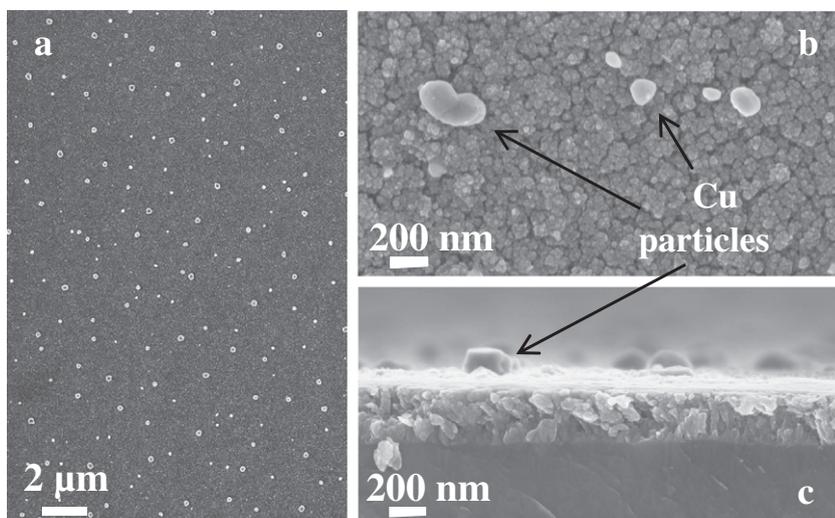


Fig. 4. Surface (a, b) and cross section (c) SEM micrographs of TiO_2 -Cu coatings (3.5 at.% Cu) showing Cu metal particles emerging from the surface of the film. Partially reprinted with permission from [31].

Table 1

Relative antibacterial activities determined by the Haldar method of two TiO₂-Cu composite coatings with different Cu contents (the CFU values reported for each sample are the average of 3 measurements).

Cu(tmhd) ₂ mole fraction (%)	0 ^a	0.076	0.15
Cu content (at.%)	0	3.5	9.0
CFU	133	129	27
Relative activity (%)	0	0.6	32

^a This sample used as reference was a pure TiO₂ film without co-deposition of copper.

100%, than for condition # 1 (20 °C/RH 40%). For instance the relative activity after 5 months of aging was approximately 50% versus 65%, respectively. This means that the performances of coatings decreased by only 35% after 5 months of aging in condition close to room temperature.

SEM observations were made after 2 and 5 months for both aging conditions and were compared with micrographs before aging (Fig. 8). At 60 °C/RH 100% (condition # 2) the surface morphology of the coating was already damaged after 2 months of aging and it is even more evident after 5 months. The SEM analysis showed that no change has been observed under condition # 1 for 5 months while under more severe condition (# 2) the average size of grains on the surface decreased from about 60 to 30 nm and formed agglomerates (Fig. 8c). X-ray diffraction pattern under grazing incidence confirmed no structural change for samples aging under condition # 1 while after 5 months under the severe condition # 2 the diffraction peaks of Cu were not detected and the intensity of those of anatase was reduced.

4. Discussion

4.1. Influence of copper content and film thickness on the antibacterial activity

In this DLICVD process the Cu content of TiO₂-Cu composite films is controlled by the Cu(tmhd)₂ mole fraction injected into the reactor (Fig. 1). The Cu incorporation in the coatings increases with the precursor mole fraction and it can reach several atomic percents but the goal was to investigate the biological behavior of the coatings without UV light for the lowest content of active agent. According to the JIS method, an antibacterial effect appears abruptly from a Cu content of ca. 1 at.% (Fig. 2). There is no antibacterial activity when Cu was not detected in the composite coating by XPS and EDS, i.e. when Cu was below the detection limit of about 1 at.%. A good reproducibility of the DLICVD process was found to control the film composition and, thereby, the Cu(tmhd)₂ mole fraction is a key parameter to control the antibacterial activity.

Table 2

ICP-AES analyses of the water after immersion of TiO₂-Cu coatings (100 nm thick) deposited on glass substrate. The immersion conditions were 24 h at 20 °C, 24 h at 40 °C, then 7 days at 40 °C. The data are compared to a 5 ppm Cu solution as reference.

Sample	Cu content (ppm)
5 ppm Cu reference solution	5.02
Uncoated glass (blank test)	0.00
TiO ₂ -Cu/24 h/20 °C	0.01
TiO ₂ -Cu/24 h/40 °C	0.01
TiO ₂ -Cu/7 days/40 °C	0.09

Beyond a Cu(tmhd)₂ mole fraction of 0.04% the antibacterial activity increases sharply and the films become bactericidal for a mole fraction of ca. 0.07% (Fig. 2). This evolution makes the control of the antibacterial activity between inactive and bactericidal (relative activity 100%) difficult. Nevertheless, the activity can be controlled by the mean of the film thickness for a constant Cu(tmhd)₂ mole fraction as shown in Fig. 3 but only for the thicknesses below 100 nm. Indeed above this critical thickness, the antibacterial activity is maximal (bactericidal). In a preliminary study [31], we showed that the dispersion of Cu particles was uniform on the surface of TiO₂-Cu composite films (SEM analyses) while a surface enrichment was observed in 300 nm thick layer (SIMS profile analyses). However different Cu particle sizes were observed ranging from 20 to 400 nm and the population density of the smallest particles (20–100 nm) was significantly greater than the largest ones (100–250 nm and >250 nm). The largest particles emerge from the surface of the coating (Fig. 4). Due to direct interaction with atmosphere the large Cu particles are probably very active in the microbiological mechanism. One hypothesis is that the largest Cu particles grow slowly and require a minimum film thickness, i.e. duration, to be formed. Solid state diffusion of copper can play a role in the formation of these largest particles since the deposition occurs around 683 K. Above a thickness threshold, probably near 100 nm, the distribution of Cu particles protruding from the surface is optimum and the film thickness effect disappears.

4.2. Other methods to determine biological activities

Because the antibacterial activity increases sharply between 1 and 3.5 at.% Cu most of the films have developed antibacterial behavior and they appear bactericidal by the JIS standard method for Cu > 3.5 at.%. Around and above this Cu content the performances of the coatings are difficult to compare. We used a kinetic method based on the JIS 2801 standard method. Fig. 5 shows that the bactericidal activity (100%) was reached faster when the film content was 3.5 at.% Cu compared to 1.3 at.% Cu: respectively, in 3 and 24 h. This modified method could be used in order to distinguish 2 films showing a

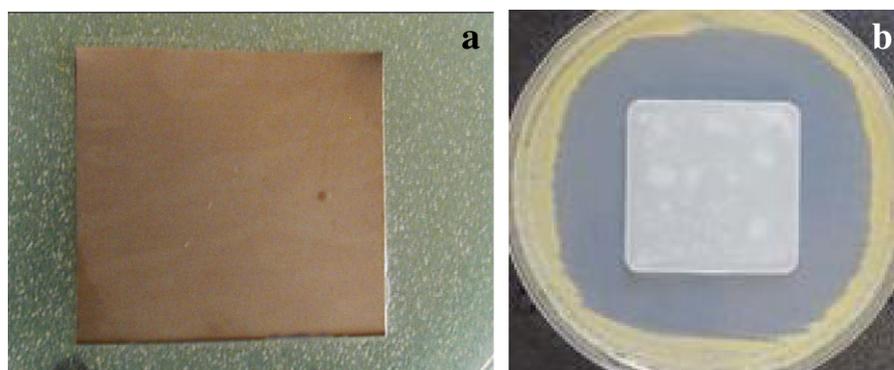


Fig. 6. Diffusion test showing that (a) no inhibition zone is observed around a 25 × 25 mm² TiO₂-Cu sample whereas (b) there is such inhibition zone (gray area) around a reference sample consisting of a piece of plastic treated with triclosan as antibacterial agent.

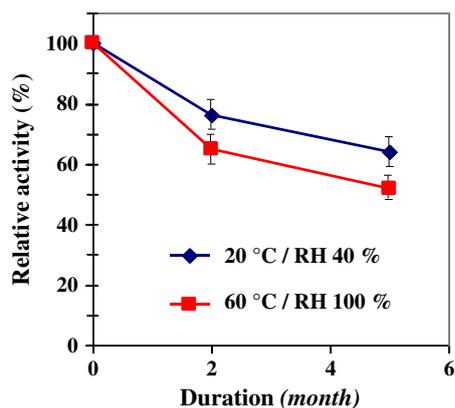


Fig. 7. Variation of the biological activities under 2 experimental aging conditions: condition # 1 (20 °C/RH 40%) and condition # 2 (60 °C/RH 100%). The decrease of the activity is greater for the most severe conditions.

bactericidal activity after 24 h. Nevertheless this method is both time and sample consuming and therefore difficult to implement.

The Haldar method [33] allows determining the antibacterial power of surfaces. The principle of this test is totally different from that of JIS Z 2801. Indeed, the bacteria are in contact with the surface during 24 h before their numeration like in JIS method, but both the antibacterial effect of the coating surface and the growth of the bacterium in its culture medium take place simultaneously (competitive routes). Preliminary data are reported in Table 1. Two TiO₂-Cu composite films that are bactericidal according to the JIS method were tested. Their composition is respectively 3.5 at.% and 9 at.% of Cu. This Haldar method shows that with the lowest Cu concentration (3.5 at.%) the surface is inactive (relative activity < 1%). The number of CFUs after the test is approximately the same on TiO₂-Cu surface as on the reference sample (Table 1). By contrast, for 9 at.% Cu the relative antibacterial activity is 32%. This method seems to be less sensitive than the JIS standard method because it is not able to detect an antibacterial activity for a sample that exhibited a bactericidal activity by the mean of JIS standard method. However it can be used to distinguish different efficiencies for two surfaces which were found at their maximum of antibacterial activity by the JIS standard method. The Haldar method involves a competition mechanism between the antibacterial effect of the surface and the development of bacteria brought by the culture medium. For the coating which contains the higher Cu content the antibacterial effect of Cu became stronger than the development of bacteria. This test is more differentiating and it can be applied usefully in addition to JIS standard method.

The antibacterial tests used in this paper involve planktonic bacteria and not adherent organisms. This could be a disadvantage when we want to study the prevention of biofouling. But, these are free bacteria that come first in contact with the surface. To prevent biofilm formation, a surface can act at different levels: (1) by preventing the adhesion thanks to surface properties, (2) by killing the bacteria in a relatively short time, before they multiply and synthesize their polysaccharide, and (3) by inhibiting the growth of adhered bacteria. The two microbiological methods used in this paper involve free bacteria but are not based on the same principle. First, in the JIS method, the bacteria are in close contact with the surface with very little nutritional factors (growth medium diluted 500 times). For example, active films which contain at least 3.5 at.% Cu kill all the bacteria deposited ($\approx 3 \times 10^5 \text{ mL}^{-1}$) within 3 h while the bacterial growth is 2 log on uncoated substrate. One might consider that these coatings avoid bacterial growth by killing them rapidly. Secondly, in the competition method [33], free bacteria are in contact with the surface for a very short time (2 min) and before being covered with pre-cut agar growth medium containing a great amount of nutrients. Therefore bacterial growth is competing with the action of the antibacterial agent and this is why this method is less sensitive than the first one. None of the 2 methods allows the development of

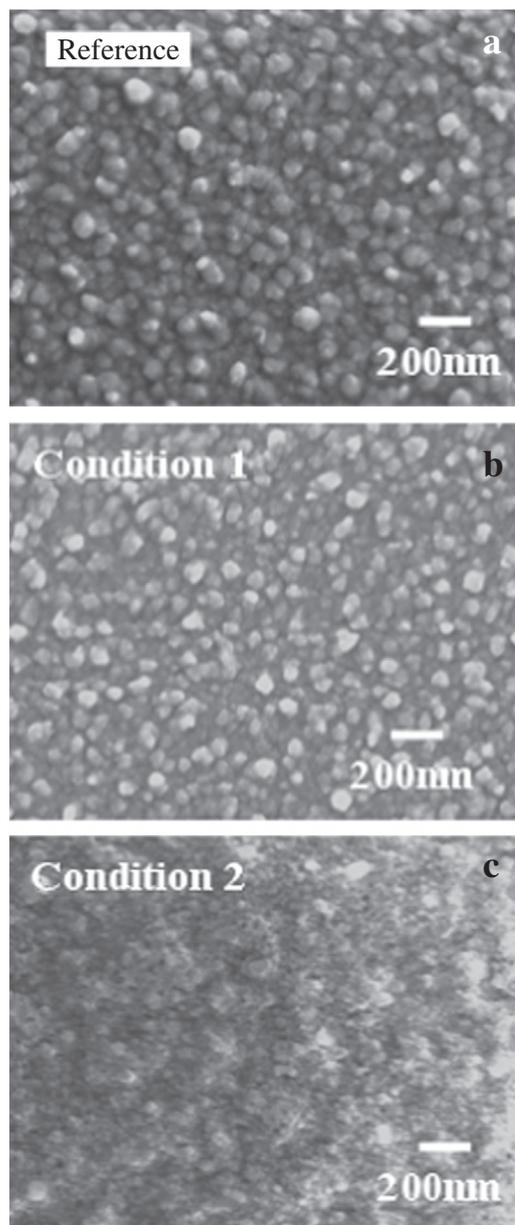


Fig. 8. Surface SEM micrographs of TiO₂-Cu coatings before (reference sample) and after aging test for 5 months under condition # 1 (20 °C/RH 40%) and condition # 2 (60 °C/RH 100%).

biofilm with adherent bacteria. For testing the capabilities of antibacterial coating to remove a preformed biofilm, adherent bacteria should be used.

4.3. Cu release from the coatings

The diffusion test is commonly used to demonstrate the release of an antiseptic compound from a solid support. An inhibition area around the support means that (i) the compound has migrated from the support, (ii) it is soluble in the water of the culture medium and (iii) the bacterial strain is able to be inhibited by the substance. Since no inhibition area around the sample has been observed, it means that no antibacterial element significantly diffuses from active TiO₂-Cu composite coatings to the environment (Fig. 6).

However this test is not sensitive enough and this is why we have analyzed the Cu traces in pure water that could originate from an immersed sample for different times. The ICP-AES data in Table 2 did not

give evidence for Cu diffusion in water. This is in agreement with the fact that Cu metal is not soluble in water. Only traces of Cu (9×10^{-2} ppm) were found after immersion for 7 days at 40 °C under gentle stirring. In these relatively drastic conditions Cu particles can be detached from the coating although immobilized by the oxide matrix and may explain these traces above the detection limit (5×10^{-3} ppm). These results indicate a good stability of the TiO₂-Cu coatings. This is clearly an advantage of using metallic nanoparticles as antibacterial agent embedded in an inorganic matrix compared to other hybrid organic-inorganic systems. Furthermore they can serve as reservoirs of active agent.

4.4. Aging

The loss of activity during aging was the most important under the most severe conditions: 60 °C/RH 100%. As shown in Fig. 8, the surface has been altered after aging with probably the formation of a copper oxide. The XRD patterns (not shown) revealed that metallic Cu structure was detected before and after aging under condition # 1 while it disappeared after aging under the more severe condition # 2. This is certainly due to the formation of copper oxide that acts as a barrier layer and therefore, the observed decrease of antibacterial activity may be due to an oxidation of the Cu particles on the surface of the sample. At 20 °C/RH 40%, the conditions were softer and the oxidation was limited compared with 60 °C/RH 100% and without consequence for the activity.

4.5. Comparison of the films containing either Cu or Ag particles

In previous studies, we developed a DLICVD process for the growth of nanostructured TiO₂-Ag films [8] related to the one used for TiO₂-Cu [31]. In the case of Ag nanocomposite coatings, the antibacterial action was higher than in the case of Cu-based coatings for a same metal content. With Ag element, the relative activity determined by the JIS standard method was 100% for a silver concentration below 1 at.%. The transition between inactivity and bactericidal effect was more abrupt than for copper, so that we did not observe any significant effect of the film thickness: thicknesses as low as 20 nm already showed significant activity. TEM analyses of films containing Ag showed that metal particles were uniformly distributed in the film thickness with an average size below 10 nm and a narrow size distribution. This is significantly different than the microstructure of TiO₂-Cu composite coatings prepared by this DLICVD process.

5. Conclusion

In this study, we developed, by DLICVD, composite coatings containing metallic Cu particles embedded in a TiO₂ matrix. The materials exhibited high antimicrobial properties against *S. aureus* tested by the mean of the JIS Z 2801:2000 standardized method. The low Cu content (3.5 at.%), and the fact that the antibacterial agent is not released in the environment suggests that these engineered surfaces do not exhibit toxic properties.

This work is part of a general program on multifunctional oxide-M coatings (M = Ag, Cu) developed for self-cleaning surface applications. For this objective, in addition to antibacterial properties, very thin thicknesses were aimed to preserve the surface appearance. Furthermore possible photocatalytic properties due to the oxide matrix would be beneficial to remove organic contamination from the surface. The coupling with photocatalytic properties is not expected for instance for SiO_x-Ag nanocomposite thin films [35] and this is an advantage of anatase matrix.

Very thin TiO₂-Cu films are quite transparent in the visible range; approximately 70% for a 150 nm thick coating containing ca. 3.5 at.% Cu. UV photocatalytic tests were performed (not reported) as described for TiO₂-Ag in [8] but bactericidal TiO₂-Cu coatings do not exhibit any photocatalytic activity. The amount of Cu in antibacterial TiO₂-Cu layers is

certainly sufficiently high (>1 at.% Cu) to annihilate any photocatalytic activity which is a property very sensitive to defects (metallic NPs with broad size distribution are defects in the oxide semiconductor matrix). Furthermore, compared with TiO₂-Ag nanocomposite coatings grown by a comparable CVD process [8], the matrix structure of TiO₂-Cu coatings changes from anatase structure to rutile by increasing the Cu content [31] and it is known that rutile is less efficient than anatase in photocatalysis [36]. As a result we have not observed simultaneously antibacterial and photocatalytic effect in TiO₂-Cu coatings grown by DLICVD in contrast with TiO₂-Ag coatings [8].

Further studies are required to determine the mechanism by which such low amounts of Cu metal particles are effective bactericidal, and to confirm that any of the metal nanoparticles are released into the environment. The antibacterial activity was determined according to two different methods. The first one, JIS Z 2801:2000 is normalized and used in laboratory to screen a lot of samples. The other, described by Haldar et al. [33] is more discriminating and for some applications more representative of real-life situations.

The aging effect of TiO₂-Cu composite films under different environmental conditions tends to slightly decrease the antibacterial efficiency but they exhibit a good durability. For instance, after 5 months in a climatic chamber under 20 °C/RH 40% and 60 °C/RH 100%, the relative antibacterial activity decreases from 100% (bactericidal) to 65% and 50%, respectively, without any cleaning treatment of the surface.

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